

Title: Electrical Contact For Compound Semiconductor Device And Method For Forming Same Inventor(s): Burton, Hong, and Canfield Ser. No.: 09/675,023; Filing Date: September 28, 2000 Replacement Page 1 of 5

FIG. 1

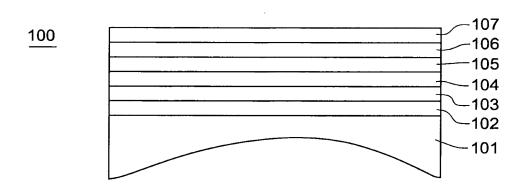
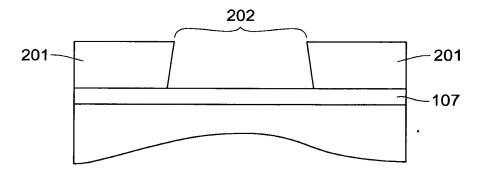


FIG. 2





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FIG. 3

301
201
301
201
107

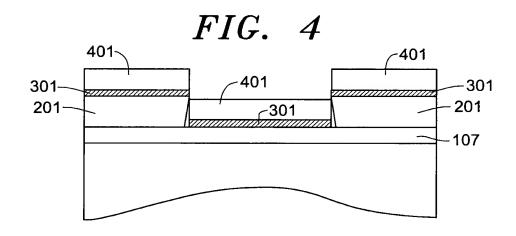


FIG. 5



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FIG. 6

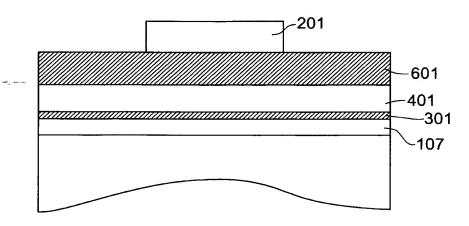


FIG.7

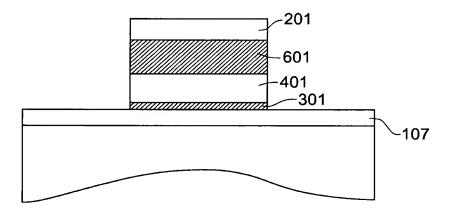
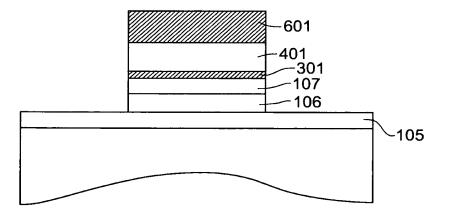


FIG.8



2012 May 27 May 20 12 May 20 May 20 12 May 20 May 20 12 May 20 May 20 May 20 12 May 20 12 May 20 12 May 20 May 20 May 20 May 20 May 20 M

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FIG.9

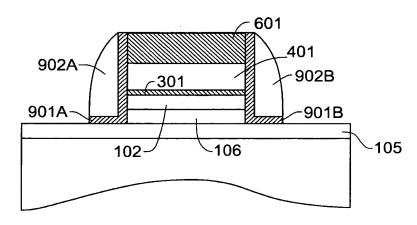
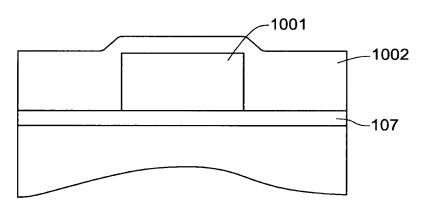
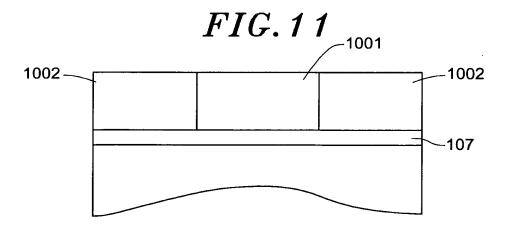


FIG. 10





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FIG. 12

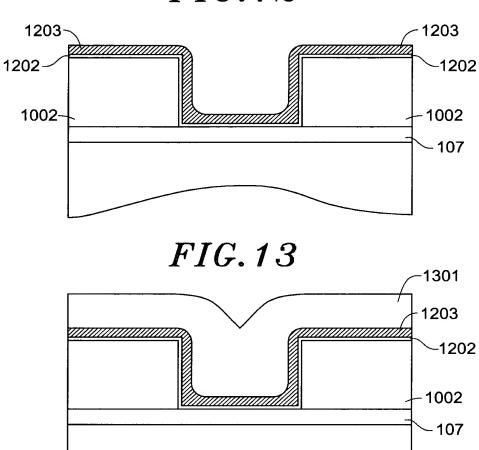


FIG. 14

